Product Data Sheet



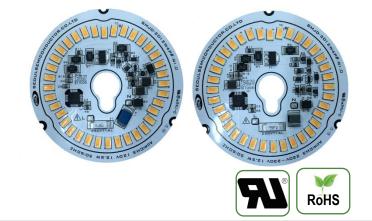
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#### SMJD-XD12W4PX - Acrich3 13W

Integrated AC LED Solution

Acrich3 – 13W

SMJD-XD12W4PX





### **Product Brief**

#### Description

- The Acrich3 series of products are designed to be driven directly off of AC line voltage, therefore they do not need the standard converter essential for conventional general lighting products.
- The converter or driver found in most general lighting products can limit the overall life of the product, but with the Acrich3 series of products the life of the product can more closely be estimated from the LED itself. This will also allow for a much smaller form factor from an overall fixture design allowing for higher creativity in the fixture.
- The modules have a high power factor which can contribute to a higher energy savings in the end application.

#### **Features and Benefits**

- Connects directly to AC line voltage
- High Power Efficiency & Factor
- Low THD
- Long Life Time
- Simple BOM
- Miniaturization
- Lead Free Product
- RoHS Compliant
- TRIAC Dimming

#### **Key Applications**

- Down Llight
- Factory Ceiling Light
- Industrial Light
- Flush Mount

	(				
Part No.	Vin [Vac]	P [W]	Color	ССТ [К]	CRI Min.
			Cool	4700 - 6000	
SMJD-2D12W4P3 SMJD-3D12W4P3	120 220	12.5	Neutral	3700 – 4200	80
31015D-3D12114F3	220		Warm	2600 – 3200	
	100		Cool	4700 - 6000	
SMJD-2D12W4P8 SMJD-3D12W4P8	120 220	12.5	Neutral	3700 – 4200	90
	220		Warm	2600 – 3200	

#### Table 1. Product Selection (CCT)

#### Table 2. Product Selection (Flux)

Part No.	Vin [Vac]	P [W]	CRI	Flux	[lm]	Remark
Fart NO.	vintvacj	L [AA]	CRI	Min.	Тур.	Remark
SMJD-2D12W4P3	120	12.5	80	880	1,130	12a
SMJD-3D12W4P3	220	12.5	80	1,130	1,360	12b
SMJD-2D12W4P8 SMJD-3D12W4P8	120 220	12.5	90	880	1,130	12a





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SMJD-XD12W4PX - Acrich3 13W

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## **Performance Characteristics**

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#### Table 3. Electro Optical Characteristics, $T_a = 25^{\circ}C$

<b>D</b>			Value		11-24	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Mark
Luminous Flux	♠ <sup>[2]</sup>	880	1360	-	las	@CRI80
Luminous Flux	$\Phi_V^{[2]}$ .	880	1130	-	- Im	@CRI90
		5300	5600	6000		В
		4700	5000	5300		С
Correlated Color Temperature <sup>[3]</sup>	ССТ	3700	4000	4200	ĸ	E
		2900	3000	3200		G
		2600	2700	2900		Н
CRI	De	80	-	-	-	P3
CRI	Ra	90	-	-	-	P8
	N	120				2V
Input Voltage <sup>[4]</sup>	V <sub>in</sub> ·		220		Vac	3V
Power Consumption	Р	11.2	12.5	13.7	W	12W
Operating Frequency	f		50 / 60		Hz	
Power Factor	PF		Over 0.97		-	
Viewing Angle	2Θ <sub>1/2</sub>		120		deg.	
Tolerance of Surge [5]	V <sub>s</sub>	500	-	-	V	

#### Notes :

- (1) At 120Vac/220Vac,  $T_a = 25^{\circ}C$
- (2)  $\Phi_V$  is the total luminous flux output measured with an integrated sphere. (Measure tolerance :  $\pm 5\%$ )
- (3) Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram.
- (4) Operating Voltage doesn't indicate the maximum voltage which customers use but means tolerable voltage according to each country's voltage variation rate. It is recommended that the solder pad temperature should be below 70 °C.
- (5) Surge withstand in accordance with IEC61000-4-5



### **Performance Characteristics**

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#### Table 4. Absolute Maximum Ratings, $T_a = 25^{\circ}C$

Parameter	Symbol	Unit	Value
Maximum Input Voltage @120Vac			140
Maximum Input Voltage @220Vac	- V <sub>in</sub>	Vac	264
Power Consumption	Р	W	16.0
Operating Temperature	Τ <sub>s</sub>	٥C	< 70 °C
Storage Temperature	T <sub>stg</sub>	٥C	-40 ~ 100
ESD Sensitivity	-	_	±4,000V HBM

#### SMJD-XD12W4PX - Acrich3 13W

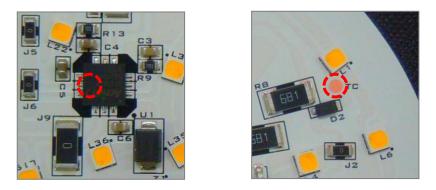
### Thermal Resistance

Table 5. Thermal information, Ta = 25°C

Part	Maximum Junction Temperature [℃]	Rθ <sub>j₅s</sub> [℃/W]
Acrich3 LED	125	9
Acrich3 IC	150	11.25

#### Notes :

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The Acrich3 module is recommended to keep the junction temperature under maximum junction

temperature spec. (Table 5)

LED lead temperature and IC top case temperature are measured with thermocupler. (Fig1)

LED & IC juntion temperatures can be calculated using the formulas below.

$$T_{s_{max}} = T_{j_{max}} - (R\theta_{j-s} * P_d)$$

< Example >

If LED lead temperature and IC top temerature are 110  $^\circ\!\!\!C$ 

1) LED juntion temperature

- $T_{J} = T_{S} + (R\theta_{j-s} * P_{d})$ 
  - = 110°C + (9 °C/W \* 0.84W) = 117.56 °C
- 2) IC junction temperature

$$T_{J} = T_{S} + (R\theta_{j-s} * P_{d})^{(1)}$$

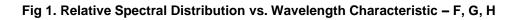
= 110°C + (11.25 °C/W \* 2.8W) = 141.5°C

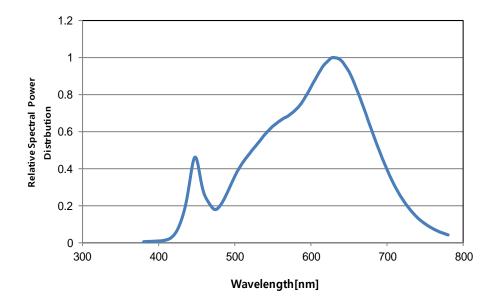
 $^{\ast}$  (1) : In the example,  $P_{d}$  value is the power consumption of IC when the rated voltage.

Rev1.3, Apr 1, 2016

SMJD-XD12W4PX - Acrich3 13W

# **Characteristic Graph**





SMJD-XD12W4PX - Acrich3 13W

# **Characteristic Graph**

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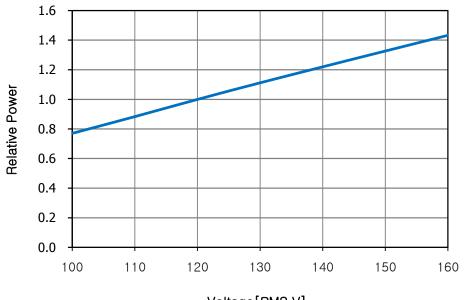
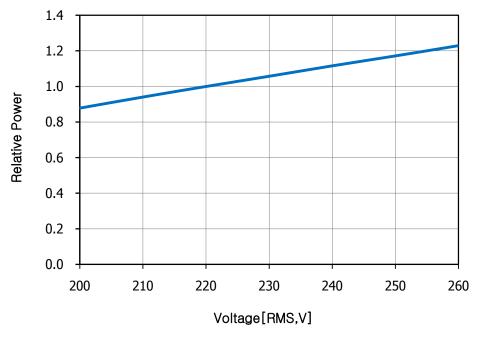


Fig 2. Relative Power Distribution vs. Voltage,  $T_a = 25 \,^{\circ}\text{C}$ , 120V

Voltage[RMS,V]

Fig 3. Relative Power Distribution vs. Voltage,  $T_a = 25 °C$ , 220V



SMJD-XD12W4PX - Acrich3 13W

# **Characteristic Graph**

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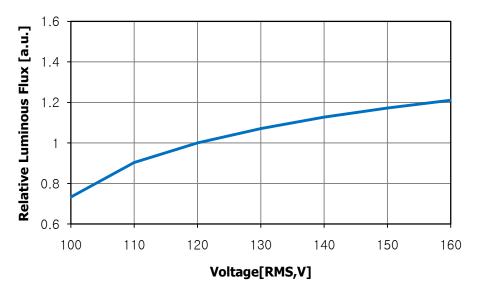
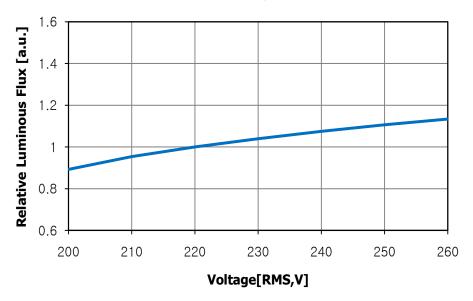


Fig 4. Relative Luminous Flux vs. Voltage,  $T_a = 25 °C$ , 120V

Fig 5. Relative Luminous Flux vs. Voltage,  $T_a = 25 \degree$ , 220V

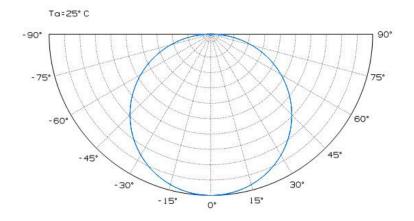




# **Characteristic Graph**

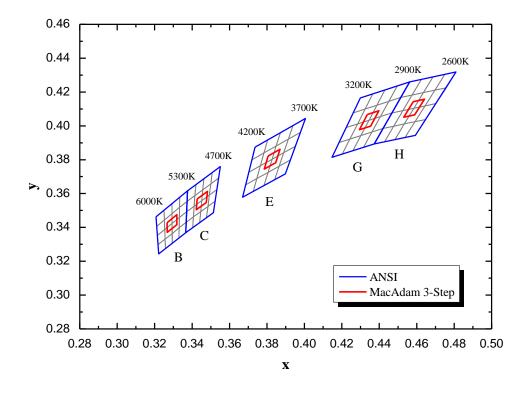
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#### Fig 6. Radiant Pattern, $T_a = 25 ^{\circ}C$





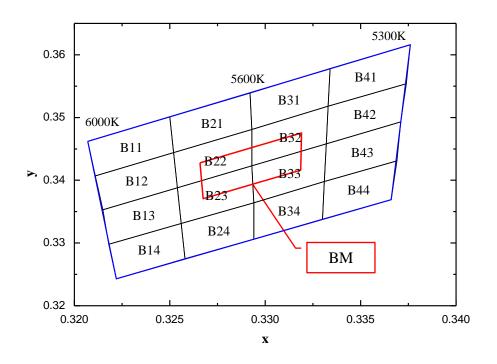
### **Color Bin Structure**



Bin	x	у	Bin	x	у	Bin	x	У
	0.3266	0.3428		0.3427	0.3568		0.3806	0.3822
вм	0.3268	0.3371	СМ	0.3423	0.3504	EM ·	0.3786	0.3745
Divi	0.3319	0.3416		0.3476	0.3547		0.3846	0.3782
	0.3319	0.3476	-	0.3482	0.3613		0.3870	0.3861
	0.4336	0.4067		0.4581	0.4143			
GM	0.4294	0.3977	нм	0.4531	0.4051			
GM	0.4354	0.3999		0.4589	0.4065			
	0.4398	0.4089	-	0.4641	0.4157			



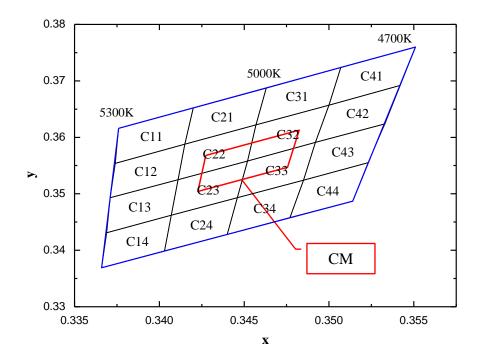
### **Color Bin Structure**



Bin	x	у	Bin	x	У	Bin	x	У	Bin	x	у
	0.3207	0.3462		0.3250	0.3501		0.3292	0.3539		0.3334	0.3578
B11	0.3211	0.3407	B21	0.3252	0.3444	B31	0.3293	0.3481	B41	0.3333	0.3518
	0.3252	0.3444		0.3293	0.3481	531	0.3333	0.3518	D41	0.3374	0.3554
	0.3250	0.3501		0.3292	0.3539		0.3334	0.3578		0.3376	0.3616
	0.3211	0.3407		0.3252	0.3444		0.3293	0.3481		0.3333	0.3518
B12	0.3215	0.3353	Boo	0.3254	0.3388	B32	0.3293	0.3423	B42	0.3332	0.3458
	0.3254	0.3388	B22	0.3293	0.3423	В32	0.3332	0.3458		0.3371	0.3493
	0.3252	0.3444		0.3293	0.3481		0.3333	0.3518		0.3374	0.3554
	0.3215	0.3353		0.3254	0.3388		0.3293	0.3423	B43	0.3332	0.3458
B13	0.3218	0.3298	B23	0.3256	0.3331	B33	0.3294	0.3364		0.3331	0.3398
БІЗ	0.3256	0.3331	BZJ	0.3294	0.3364	633	0.3331	0.3398		0.3369	0.3431
	0.3254	0.3388		0.3293	0.3423		0.3332	0.3458		0.3371	0.3493
	0.3218	0.3298		0.3256	0.3331		0.3294	0.3364		0.3331	0.3398
B14	0.3222	0.3243	B24	0.3258	0.3275	B34	0.3294	0.3306	B//	0.3330	0.3338
	0.3258	0.3275	D24	0.3294	0.3306	034	0.3330	0.3338	— <b>В44</b> 3	0.3366	0.3369
	0.3256	0.3331		0.3294	0.3364		0.3331	0.3398		0.3369	0.3431



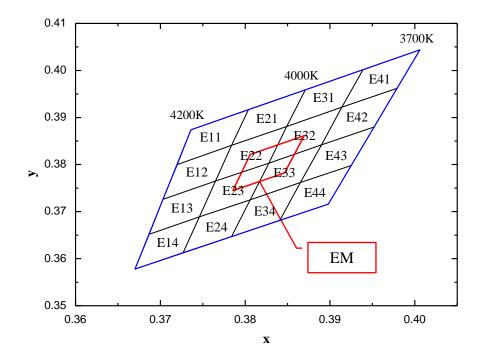
## **Color Bin Structure**



Bin	x	у	Bin	x	У	Bin	x	у	Bin	x	у
	0.3376	0.3616		0.3420	0.3652		0.3463	0.3687		0.3507	0.3724
011	0.3374	0.3554	604	0.3415	0.3588	004	0.3457	0.3622	C41	0.3500	0.3657
C11	0.3415	0.3588	C21	0.3457	0.3622	C31	0.3500	0.3657	641	0.3542	0.3692
	0.3420	0.3652		0.3463	0.3687		0.3507	0.3724		0.3551	0.3760
	0.3374	0.3554		0.3415	0.3588		0.3457	0.3622		0.3500	0.3657
C12	0.3371	0.3493	<b>C</b> 22	0.3411	0.3525	<b>C</b> 22	0.3452	0.3558	C42	0.3492	0.3591
	0.3411	0.3525	C22	0.3452	0.3558	C32	0.3492	0.3591		0.3533	0.3624
	0.3415	0.3588		0.3457	0.3622		0.3500	0.3657		0.3542	0.3692
	0.3371	0.3493		0.3411	0.3525		0.3452	0.3558	C43	0.3492	0.3591
C13	0.3369	0.3431	C23	0.3407	0.3462	C33	0.3446	0.3493		0.3485	0.3524
	0.3407	0.3462	623	0.3446	0.3493	633	0.3485	0.3524		0.3523	0.3555
	0.3411	0.3525		0.3452	0.3558		0.3492	0.3591		0.3533	0.3624
	0.3369	0.3431		0.3407	0.3462		0.3446	0.3493		0.3485	0.3524
C14	0.3366	0.3369	C24	0.3403	0.3399	C34	0.3440	0.3428	— C44	0.3477	0.3458
	0.3403	0.3399	624	0.3440	0.3428	034	0.3477	0.3458		0.3514	0.3487
	0.3407	0.3462		0.3446	0.3493		0.3485	0.3524		0.3523	0.3555



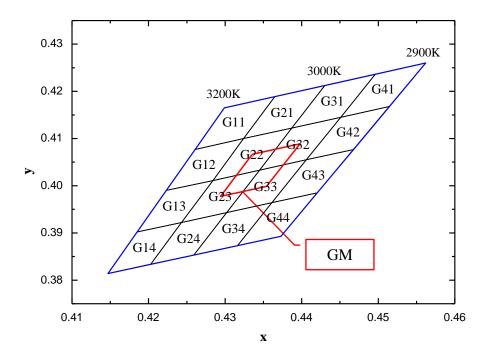
## **Color Bin Structure**



Bin	x	у	Bin	x	У	Bin	x	У	Bin	x	у
	0.3736	0.3874		0.3804	0.3917		0.3871	0.3959		0.3939	0.4002
	0.3720	0.3800	F04	0.3784	0.3841	<b>F</b> 24	0.3849	0.3881	E41	0.3914	0.3922
E11	0.3784	0.3841	E21	0.3849	0.3881	E31	0.3914	0.3922	L41	0.3979	0.3962
	0.3804	0.3917		0.3871	0.3959		0.3939	0.4002		0.4006	0.4044
	0.3720	0.3800		0.3784	0.3841		0.3849	0.3881		0.3914	0.3922
E12	0.3703	0.3726	Faa	0.3765	0.3765	E30	0.3828	0.3803	E42	0.3890	0.3842
	0.3765	0.3765	E22	0.3828	0.3803	E32	0.3890	0.3842		0.3952	0.3880
	0.3784	0.3841		0.3849	0.3881		0.3914	0.3922		0.3979	0.3962
	0.3703	0.3726		0.3765	0.3765		0.3828	0.3803	E43	0.3890	0.3842
E13	0.3687	0.3652	E02	0.3746	0.3689	E33	0.3806	0.3725		0.3865	0.3762
E13	0.3746	0.3689	E23	0.3806	0.3725	E33	0.3865	0.3762		0.3925	0.3798
	0.3765	0.3765		0.3828	0.3803		0.3890	0.3842		0.3952	0.3880
	0.3687	0.3652		0.3746	0.3689		0.3806	0.3725		0.3865	0.3762
E14	0.3670	0.3578	E24	0.3727	0.3613	E34	0.3784	0.3647	E44	0.3841	0.3682
	0.3727	0.3613	<b>E24</b> 0.3784	0.3784	0.3647	⊏34	0.3841	0.3682	⊑44	0.3898	0.3716
	0.3746	0.3689		0.3806	0.3725		0.3865	0.3762		0.3925	0.3798



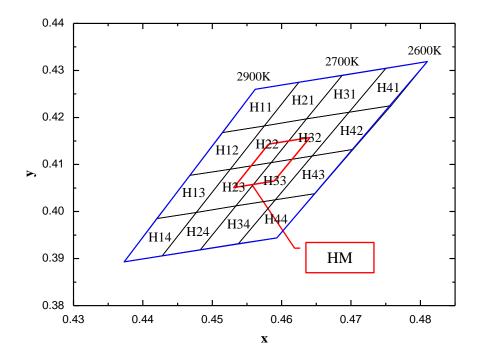
### **Color Bin Structure**



Bin	x	у									
	0.4299	0.4165		0.4364	0.4188		0.4430	0.4212		0.4496	0.4236
011	0.4261	0.4077	004	0.4324	0.4099	G31	0.4387	0.4122	G41	0.4451	0.4145
G11	0.4324	0.4100	G21	0.4387	0.4122	631	0.4451	0.4145		0.4514	0.4168
	0.4365	0.4189		0.4430	0.4212		0.4496	0.4236		0.4562	0.4260
	0.4261	0.4077		0.4324	0.4100		0.4387	0.4122		0.4451	0.4145
G12	0.4223	0.3990	G22	0.4284	0.4011	633	0.4345	0.4033	G42	0.4406	0.4055
012	0.4284	0.4011	922	0.4345	0.4033	G32	0.4406	0.4055		0.4468	0.4077
	0.4324	0.4100		0.4387	0.4122		0.4451	0.4145		0.4515	0.4168
	0.4223	0.3990		0.4284	0.4011		0.4345	0.4033	G43	0.4406	0.4055
G13	0.4185	0.3902	G23	0.4243	0.3922	G33	0.4302	0.3943		0.4361	0.3964
GIS	0.4243	0.3922	625	0.4302	0.3943	633	0.4361	0.3964		0.4420	0.3985
	0.4284	0.4011		0.4345	0.4033		0.4406	0.4055		0.4468	0.4077
	0.4243	0.3922		0.4302	0.3943		0.4302	0.3943		0.4361	0.3964
G14	0.4203	0.3834	G24	0.4259	0.3853	G34	0.4259	0.3853	G44	0.4316	0.3873
	0.4147	0.3814	624	0.4203	0.3834	654	0.4316	0.3873	044	0.4373	0.3893
	0.4185	0.3902		0.4243	0.3922		0.4361	0.3964		0.4420	0.3985



### **Color Bin Structure**



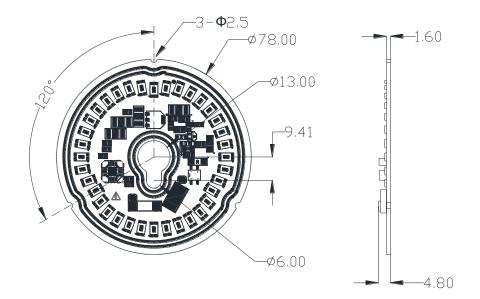
Bin	x	у	Bin	x	У	Bin	x	У	Bin	x	у
	0.4562	0.4260		0.4625	0.4275		0.4687	0.4289		0.4750	0.4304
	0.4515	0.4168	H21	0.4575	0.4182	1124	0.4636	0.4197	H41	0.4697	0.4211
H11	0.4575	0.4182	<b>H</b> 21	0.4636	0.4197	H31	0.4697	0.4211	-	0.4758	0.4225
	0.4625	0.4275		0.4687	0.4289		0.4750	0.4304		0.4810	0.4319
	0.4515	0.4168		0.4575	0.4182		0.4636	0.4197		0.4697	0.4211
H12	0.4468	0.4077	H22	0.4526	0.4090	<b>U</b> 22	0.4585	0.4104	H42	0.4644	0.4118
	0.4526	0.4090	П22	0.4585	0.4104	H32	0.4644	0.4118		0.4703	0.4132
	0.4575	0.4182		0.4636	0.4197		0.4697	0.4211		0.4758	0.4225
	0.4468	0.4077		0.4526	0.4090		0.4585	0.4104	H43	0.4644	0.4118
H13	0.4420	0.3985	ЦЭЭ	0.4477	0.3998	L122	0.4534	0.4012		0.4591	0.4025
	0.4477	0.3998	H23	0.4534	0.4012	H33	0.4591	0.4025		0.4648	0.4038
	0.4526	0.4090		0.4585	0.4104		0.4644	0.4118		0.4703	0.4132
	0.4420	0.3985		0.4477	0.3998		0.4534	0.4012		0.4591	0.4025
H14	0.4373	0.3893	LD4	0.4428	0.3906	LI24	0.4483	0.3919	ЦЛЛ	0.4538	0.3932
	0.4428	0.3906	H24 –	0.4483	0.3919	- H34	0.4538	0.3932	— <b>H44</b> 2	0.4593	0.3944
	0.4477	0.3998		0.4534	0.4012		0.4591	0.4025		0.4648	0.4038



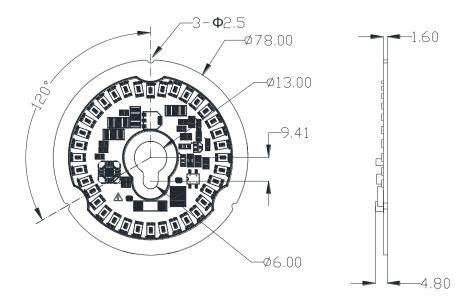
SMJD-XD12W4PX - Acrich3 13W

### **Mechanical Dimensions**

#### SMJD-2D12W4PX



#### SMJD-3D12W4PX



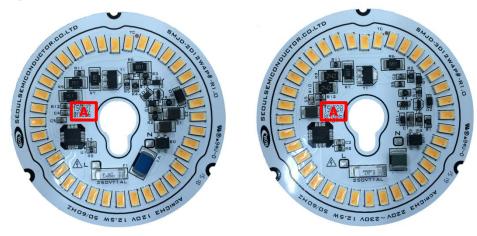
#### Notes :

- (1) All dimensions are in millimeters. (Tolerance :  $\pm 0.2$ )
- (2) Scale : None

SMJD-XD12W4PX - Acrich3 13W

# **Marking Information**

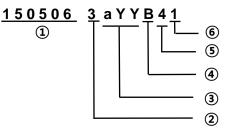
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A : Marking

ex) 150506 a3YYB41

#### - Description



- ① SMT Date (YYMMDD, 6 Digits)
- ② CRI (1 Digits)
- ③ Module Flux Bin (3 Digits)
- ④ CCT (1 Digit)
- **(5)** CCT Combination NO. (1 Digit)
- **⑥** VF Combination NO. (1 Digit)

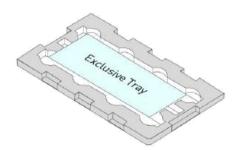
2		3				(4), (5)			6		
Marking	CRI	Туре	Marking	Min	Тур.	Marking	Bin A	Bin B	Marking	Bin A	Bin B
3	80		WW			*0	*22	*33	1	D1	D1
8	90	а	XX	880	1130	*1	*23	*32	2	D1	D2
			YY			*2	*33	*22	3	D2	D1
		b	ZZ	1130	1360	*3	*32	*23	4	D1	D3
		b b	JJ	1150	1300	*4	*MC	*MC	5	D3	D1
						*5	*22	*22	6	D2	D2
						*6	*23	*23	7	D2	D3
						*7	*32	*32	8	D3	D2
						*8	*33	*33	9	D3	D3
						*9	*22	*34	_		
						*A	*22	*43	-		
						*B	*22	*44			
						*C	*23	*31	_		
						*D	*23	*41	_		
						*E	*23	*42			
						*F	*32	*13	_		
						*G	*32	*14	_		
						*H	*32	*24			
						*	*33	*11	-		
						*J	*33	*12	-		
						*K	*33	*21			



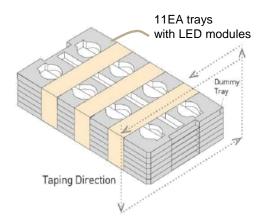
# Packing

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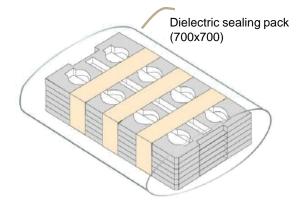
1. Tray information



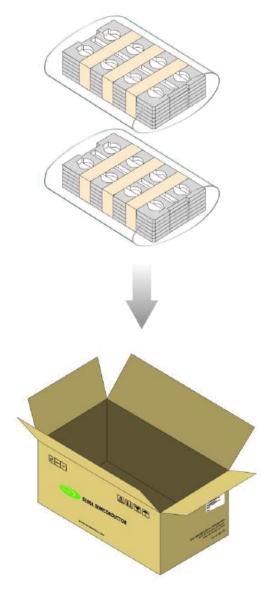
- 24 PCS LED modules packed per tray
- 2. Tray stack and taping



- 11EA LED module trays and additional 1 dummy trays each up of box
- Add silica gel (1EA) on top of the tray
- 3. Sealing packing



4. Box information & packing



- 240 PCS modules per BOX 1EA
- \*\* 1Box : 24 PCS per tray x 10 trays = 240 PCS

### **Label Information**

SEOUL

Model No.	SMJD-XD12W4PX <sup>(1)</sup>				
Rank	12bG803 <sup>(2)</sup>				
Туре	3-step <sup>(3)</sup>				
Quantity	<b>XX</b>				
Date					
SEOUL	SEOUL SEMICONDUCTOR CO.,LTD.				

#### Notes

- (1) The model number designation is explained as follow SMJD : Seoul Semiconductor internal code XD : Input Voltage (2D = 120V, 3D = 220V) 12W : About Power Consumption 4 : Acrich IC Version 3.0 PX: MJT PKG (D=SAW8KG0B, E=SAW9KG0B)
- (2) It represents Module Optical SPEC. Luminous flux : 12a, 12b, 12c CCT : H~B CRI : 80 or 90
   CIE Area 2 or 1(2 top or 4 top)
- CIE Area : 3 or 4(3step or 4step) (3) It represents module CIE SPEC
  - CIE Area : 3step or 4step
- (4) It is attached to the top of a sealing pack & the bottom right corner of the box.

TOTAL Quantity
SEOUL SEMICONDUCTOR CO.,LTD.

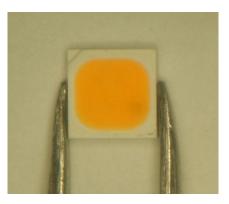
(1) It is attached to the bottom right corner of the box.

SEOUL



### Handling of Silicone Resin for LEDs





- (1) Acrich3 series is encapsulated with silicone resin for high optical efficiency.
- (2) Please do not touch the silicone resin area with sharp objects such as pincette(tweezers).

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- (3) Finger prints on silicone resin area may affect the performance.
- (4) Please store LEDs in covered containers to prevent dust accumulation as this may affect performance.
- (5) Excessive force more than 3000gf to the silicone lens can result in fatal or permanent damage with LEDs.
- (6) Please do not cover the silicone resin area with any other resins such as epoxy, urethane, etc.



## **Precaution for Use**

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- (1) Please review the Acrich3 Application Note for proper protective circuitry usage.
- (2) Please note, Acrich3 products run off of high voltage, therefore caution should be taken when working near Acrich3 products.
- (3) Make sure proper discharge prior to starting work.
- (4) DO NOT touch any of the circuit board, components or terminals with body or metal while circuit is active.
- (5) Please do not add or change wires while Acrich3 circuit is active.
- (6) Long time exposure to sunlight or UV can cause the lens to discolor.
- (7) Please do not use adhesives to attach the LED that outgas organic vapor.
- (8) Please do not use together with the materials containing Sulfur.
- (9) Please do not assemble in conditions of high moisture and/or oxidizing gas such as Cl, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, NO<sub>x</sub>, etc.
- (10) Please do not make any modification on module.
- (11) Please be cautious when soldering to board so as not to create a short between different trace patterns.
- (12) Do not impact or place pressure on this product because even a small amount of pressure can damage the product. The product should also not be placed in high temperatures, high humidity or direct sunlight since the device is sensitive to these conditions.
- (13) When storing devices for a long period of time before usage, please following these guidelines:
  \* The devices should be stored in the anti-static bag that it was shipped in from Seoul-Semiconductor with opening.
  - \* If the anti-static bag has been opened, re-seal preventing air and moisture from being present in the bag.
- (14) LEDs and IC are sensitive to Electro-Static Discharge (ESD) and Electrical Over Stress (EOS). The Acrich3 product should also not be installed in end equipment without ESD protection. Below is a list of suggestions that Seoul Semiconductor purposes to minimize these effects.
- a. ESD (Electro Static Discharge)

Electrostatic discharge (ESD) is the defined as the release of static electricity when two objects come into contact. While most ESD events are considered harmless, it can be an expensive problem in many industrial environments during production and storage. The damage from ESD to an LEDs may cause the product to demonstrate unusual characteristics such as:



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### **Precaution for Use**

- Increase in reverse leakage current lowered turn-on voltage
- Abnormal emissions from the LED at low current

The following recommendations are suggested to help minimize the potential for an ESD event. One or more recommended work area suggestions:

- Ionizing fan setup
- ESD table/shelf mat made of conductive materials
- ESD safe storage containers

One or more personnel suggestion options:

- Antistatic wrist-strap
- Antistatic material shoes
- Antistatic clothes

Environmental controls:

- Humidity control (ESD gets worse in a dry environment)

#### b. EOS (Electrical Over Stress)

Electrical Over-Stress (EOS) is defined as damage that may occur when an electronic device is subjected to a current or voltage that is beyond the maximum specification limits of the device. The effects from an EOS event can be noticed through product performance like:

- Changes to the performance of the LED package (If the damage is around the bond pad area and since the package is completely encapsulated
- the package may turn on but flicker show severe performance degradation.)
- Changes to the light output of the luminaire from component failure
- Components on the board not operating at determined drive power

Failure of performance from entire fixture due to changes in circuit voltage and current across total circuit causing trickle down failures. It is impossible to predict the failure mode of every LED exposed to electrical overstress as the failure modes have been investigated to vary, but there are some common signs that will indicate an EOS event has occurred:

- Damaged may be noticed to the bond wires (appearing similar to a blown fuse)
- Damage to the bond pads located on the emission surface of the LED package (shadowing can be noticed around the bond pads while viewing through a microscope)
- Anomalies noticed in the encapsulation and phosphor around the bond wires
- This damage usually appears due to the thermal stress produced during the EOS event
- c. To help minimize the damage from an EOS event Seoul Semiconductor recommends utilizing:
  - A surge protection circuit
  - An appropriately rated over voltage protection device
  - A current limiting device





## **Company Information**

#### Published by

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#### **Company Information**

Seoul Semiconductor (www.SeoulSemicon.com) manufacturers and packages a wide selection of light emitting diodes (LEDs) for the automotive, general illumination/lighting, Home appliance, signage and back lighting markets. The company is the world's fifth largest LED supplier, holding more than 10,000 patents globally, while offering a wide range of LED technology and production capacity in areas such as "nPola", "Acrich", the world's first commercially produced AC LED, and "Acrich MJT - Multi-Junction Technology" a proprietary family of high-voltage LEDs.

The company's broad product portfolio includes a wide array of package and device choices such as Acrich and Acirch2, high-brightness LEDs, mid-power LEDs, side-view LEDs, and through-hole type LEDs as well as custom modules, displays, and sensors.

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